

## PACKAGING INFORMATION

Orderable part number	Status (1)	Material type (2)	Package   Pins	Package qty   Carrier	<b>RoHS</b> (3)	Lead finish/ Ball material (4)	MSL rating/ Peak reflow	Op temp (°C)	Part marking (6)
UCC256402ADDBR	Active	Production	SOIC (DDB)   14	2500   LARGE T&R	Yes	NIPDAU	Level-2-260C-1 YEAR	-40 to 125	UCC256402A
UCC256402ADDBR.Z	Active	Production	SOIC (DDB)   14	2500   LARGE T&R	Yes	NIPDAU	Level-2-260C-1 YEAR	-40 to 125	UCC256402A
UCC256402ADDBT	Active	Production	SOIC (DDB)   14	250   SMALL T&R	Yes	NIPDAU	Level-2-260C-1 YEAR	-40 to 125	UCC256402A
UCC256402ADDBT.Z	Active	Production	SOIC (DDB)   14	250   SMALL T&R	Yes	NIPDAU	Level-2-260C-1 YEAR	-40 to 125	UCC256402A
UCC256402DDBR	Active	Production	SOIC (DDB)   14	2500   LARGE T&R	Yes	NIPDAU	Level-2-260C-1 YEAR	-40 to 125	UCC256402
UCC256402DDBR.Z	Active	Production	SOIC (DDB)   14	2500   LARGE T&R	Yes	NIPDAU	Level-2-260C-1 YEAR	-40 to 125	UCC256402
UCC256402DDBT	Active	Production	SOIC (DDB)   14	250   SMALL T&R	Yes	NIPDAU	Level-2-260C-1 YEAR	-40 to 125	UCC256402
UCC256402DDBT.Z	Active	Production	SOIC (DDB)   14	250   SMALL T&R	Yes	NIPDAU	Level-2-260C-1 YEAR	-40 to 125	UCC256402
UCC256403ADDBR	Active	Production	SOIC (DDB)   14	2500   LARGE T&R	Yes	NIPDAU	Level-2-260C-1 YEAR	-40 to 125	UCC256403A
UCC256403ADDBR.Z	Active	Production	SOIC (DDB)   14	2500   LARGE T&R	Yes	NIPDAU	Level-2-260C-1 YEAR	-40 to 125	UCC256403A
UCC256403DDBR	Active	Production	SOIC (DDB)   14	2500   LARGE T&R	Yes	NIPDAU	Level-2-260C-1 YEAR	-40 to 125	UCC256403
UCC256403DDBR.Z	Active	Production	SOIC (DDB)   14	2500   LARGE T&R	Yes	NIPDAU	Level-2-260C-1 YEAR	-40 to 125	UCC256403
UCC256403DDBT	Active	Production	SOIC (DDB)   14	250   SMALL T&R	Yes	NIPDAU	Level-2-260C-1 YEAR	-40 to 125	UCC256403
UCC256403DDBT.Z	Active	Production	SOIC (DDB)   14	250   SMALL T&R	Yes	NIPDAU	Level-2-260C-1 YEAR	-40 to 125	UCC256403
UCC256404ADDBR	Active	Production	SOIC (DDB)   14	2500   LARGE T&R	Yes	NIPDAU	Level-2-260C-1 YEAR	-40 to 125	UCC256404A
UCC256404ADDBR.Z	Active	Production	SOIC (DDB)   14	2500   LARGE T&R	Yes	NIPDAU	Level-2-260C-1 YEAR	-40 to 125	UCC256404A
UCC256404ADDBT	Active	Production	SOIC (DDB)   14	250   SMALL T&R	Yes	NIPDAU	Level-2-260C-1 YEAR	-40 to 125	UCC256404A
UCC256404ADDBT.Z	Active	Production	SOIC (DDB)   14	250   SMALL T&R	Yes	NIPDAU	Level-2-260C-1 YEAR	-40 to 125	UCC256404A
UCC256404BDDBR	Active	Production	SOIC (DDB)   14	2500   LARGE T&R	Yes	NIPDAU	Level-2-260C-1 YEAR	-40 to 125	UCC256404B
UCC256404BDDBR.Z	Active	Production	SOIC (DDB)   14	2500   LARGE T&R	Yes	NIPDAU	Level-2-260C-1 YEAR	-40 to 125	UCC256404B
UCC256404DDBR	Active	Production	SOIC (DDB)   14	2500   LARGE T&R	Yes	NIPDAU	Level-2-260C-1 YEAR	-40 to 125	UCC256404
UCC256404DDBR.Z	Active	Production	SOIC (DDB)   14	2500   LARGE T&R	Yes	NIPDAU	Level-2-260C-1 YEAR	-40 to 125	UCC256404
UCC256404DDBT	Active	Production	SOIC (DDB)   14	250   SMALL T&R	Yes	NIPDAU	Level-2-260C-1 YEAR	-40 to 125	UCC256404
UCC256404DDBT.Z	Active	Production	SOIC (DDB)   14	250   SMALL T&R	Yes	NIPDAU	Level-2-260C-1 YEAR	-40 to 125	UCC256404

<sup>(1)</sup> **Status:** For more details on status, see our product life cycle.

<sup>(2)</sup> Material type: When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.



## PACKAGE OPTION ADDENDUM

<sup>(3)</sup> RoHS values: Yes, No, RoHS Exempt. See the TI RoHS Statement for additional information and value definition.

<sup>(4)</sup> Lead finish/Ball material: Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

<sup>(5)</sup> MSL rating/Peak reflow: The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

<sup>(6)</sup> Part marking: There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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